

- Independent Asynchronous Inputs and Outputs
- 64 Words by 9 Bits
- Data Rates From 0 to 40 MHz
- Fall-Through Time . . . 20 ns Typical
- 3-State Outputs

description

This 576-bit memory uses advanced low-power Schottky IMPACT-X™ technology and features high speed and fast fall-through times. It is organized as 64 words by 9 bits.

A FIFO memory is a storage device that allows data to be written into and read from its array at independent data rates. The function is used as a buffer to couple two buses operating at different clock rates. This FIFO is designed to process data at rates from 0 to 40 MHz in a bit-parallel format, word by word.

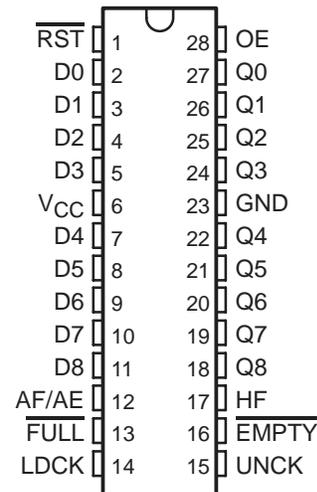
Data is written into memory on a low-to-high transition of the load clock (LDCK) input and is read out on a low-to-high transition of the unload clock (UNCK) input. The memory is full when the number of words clocked in exceeds by 64 the number of words clocked out. When the memory is full, LDCK signals have no effect on the data residing in memory. When the the memory is empty, UNCK signals have no effect.

Status of the FIFO memory is monitored by the FULL, EMPTY, almost-full/almost-empty (AF/AE), and half-full (HF) output flags. The FULL output is low when the memory is full and high when the memory is not full. The EMPTY output is low when the memory is empty, and high when it is not empty. The AF/AE flag is high when the FIFO contains eight or less words or 56 or more words. The AF/AE flag is low when the FIFO contains between nine and 55 words. The HF flag is high when the FIFO contains 32 or more words and is low when the FIFO contains 31 words or less.

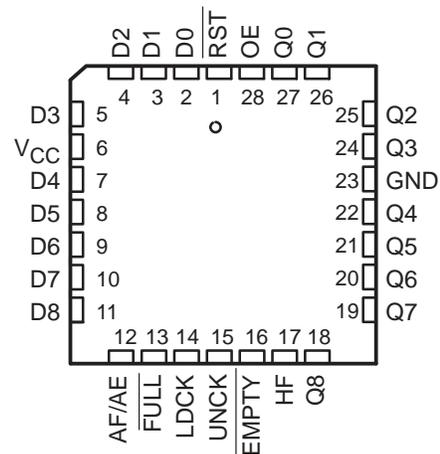
A low level on the reset ($\overline{\text{RST}}$) input resets the internal stack control pointers and also sets $\overline{\text{EMPTY}}$ low and $\overline{\text{FULL}}$ high. The outputs are not reset to any specific logic levels. The first low-to-high transition on LDCK, either after a RST pulse or from an empty condition, causes $\overline{\text{EMPTY}}$ to go high and the data to appear on the Q outputs. The first word does not have to be unloaded. Data outputs are noninverting with respect to the data inputs and are at a high-impedance state when the output-enable (OE) input is low. The OE input does not effect either the $\overline{\text{FULL}}$ or $\overline{\text{EMPTY}}$ output flags. Cascading is easily accomplished in the word-width direction, but is not possible in the word-depth direction.

The SN74ALS2233A is characterized for operation from 0°C to 70°C.

N PACKAGE
(TOP VIEW)



FN PACKAGE
(TOP VIEW)



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 **TEXAS
INSTRUMENTS**

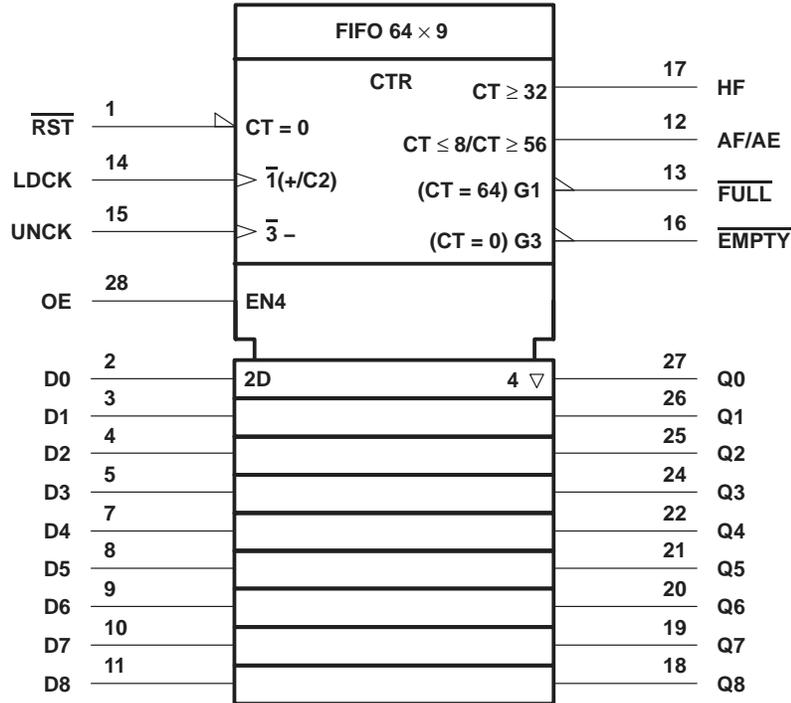
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SN74ALS2233A 64 × 9 ASYNCHRONOUS FIRST-IN, FIRST-OUT MEMORY

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logic symbol†



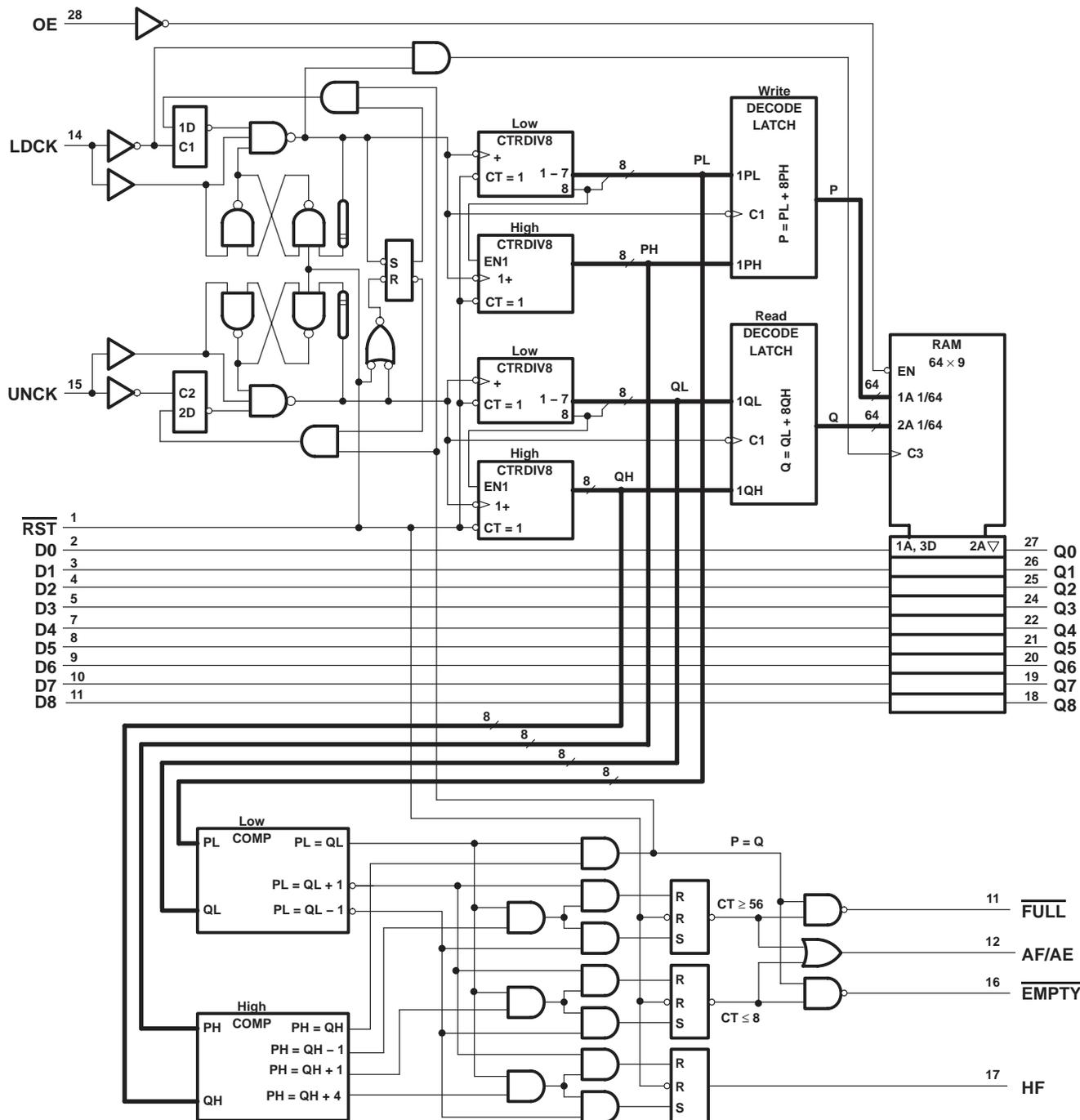
† This symbol is in accordance with ANSI/IEEE Standard 91-1984 and IEC Publication 617-12. The symbol is functionally accurate but does not show the details of implementation; for these, see the logic diagram. The symbol represents the memory as if it were controlled by a single counter whose content is the number of words stored at the time. Output data is invalid when the counter content (CT) is 0.

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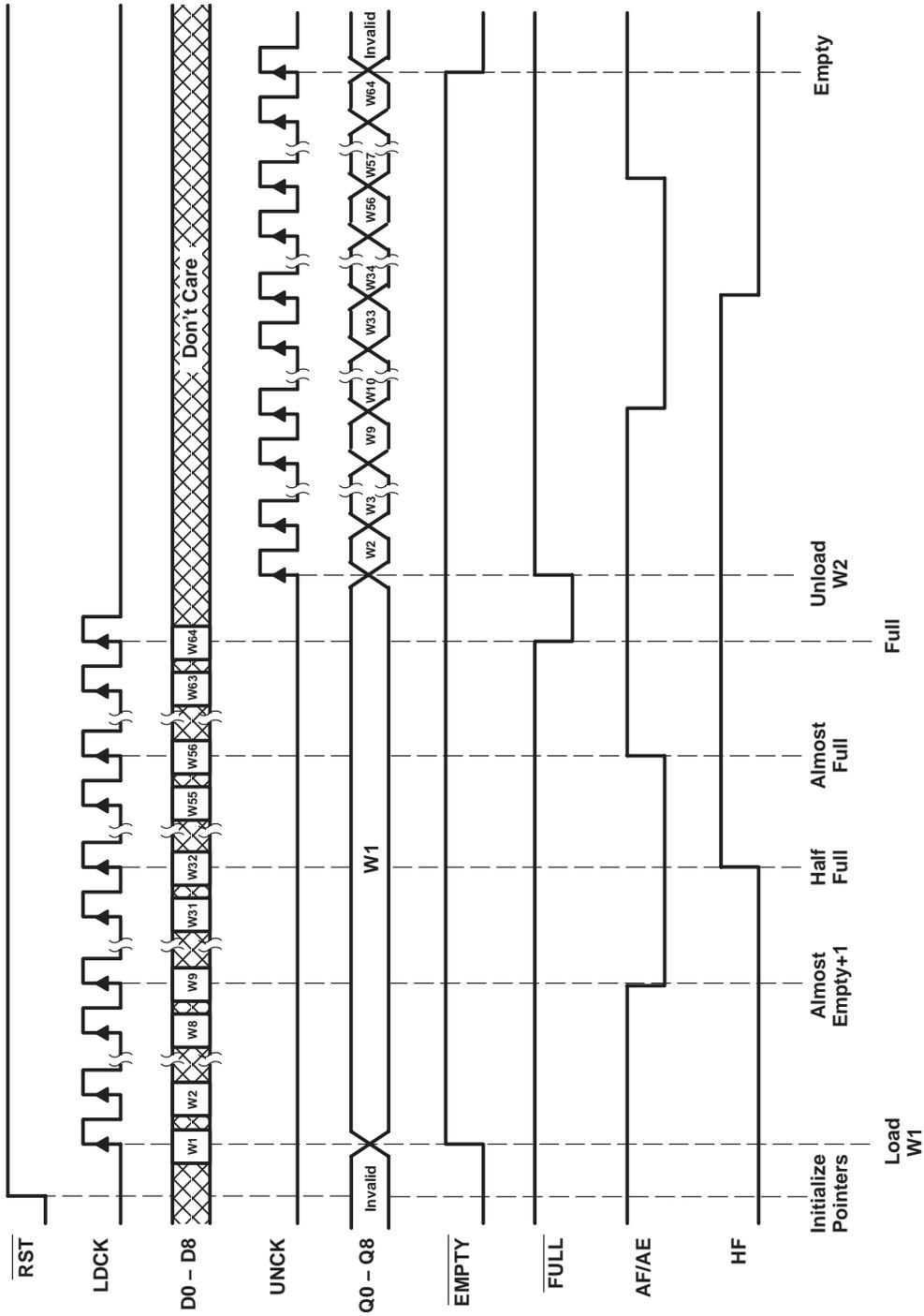
logic diagram (positive logic)



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timing diagram



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T_A	0°C to 70°C
Storage temperature range	– 65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the “recommended operating conditions” section of this specification is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND.

recommended operating conditions

		MIN	NOM	MAX	UNIT	
V_{CC}	Supply voltage	4.5	5	5.5	V	
V_{IH}	High-level input voltage	2			V	
V_{IL}	Low-level input voltage			0.8	V	
I_{OH}	High-level output current	Q outputs		–2.6	mA	
		Flag outputs		–0.4		
I_{OL}	Low-level output current	Q outputs		24	mA	
		Flag outputs		8		
f_{clock}	Clock frequency	LDCK, UNCK		0	40	MHz
t_w	Pulse duration	\overline{RST} low		25	ns	
		LDCK low		13		
		LDCK high		12		
		UNCK low		13		
		UNCK high		12		
t_{su1}	Setup time, data before LDCK↑	5			ns	
t_{su2}	Setup time, \overline{RST} high (inactive) before LDCK↑	5			ns	
t_h	Hold time, data after LDCK↑	5			ns	
T_A	Operating free-air temperature	0		70	°C	



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		MIN	TYP‡	MAX	UNIT
V _{IK}		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2	V
V _{OH}	Q outputs	V _{CC} = 4.5 V,	I _{OH} = -2.6 mA	2.4	3.2		V
	Flag outputs	V _{CC} = MIN to MAX,	I _{OH} = 0.4 mA	V _{CC} -2			
V _{OL}	Q outputs	V _{CC} = 4.5 V	I _{OL} = 12 mA	0.25	0.4		V
			I _{OL} = 24 mA	0.35	0.5		
	Flag outputs	V _{CC} = 4.5 V	I _{OL} = 4 mA	0.25	0.4		
			I _{OL} = 8 mA	0.35	0.5		
I _{OZH}		V _{CC} = 5.5 V,	V _O = 2.7 V			20	μA
I _{OZL}		V _{CC} = 5.5 V,	V _O = 0.4 V			-20	μA
I _I		V _{CC} = 5.5 V,	V _I = 7 V			0.1	mA
I _{IH}		V _{CC} = 5.5 V,	V _I = 2.7 V			20	μA
I _{IL}	CLKs	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.2	mA
	Others					-0.1	
I _O §	Q outputs	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-130	mA
	Flag outputs			-20		-112	
I _{CC}		V _{CC} = 5.5 V		175		290	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.



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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 5 V, C _L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T _A = 25°C			V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T _A = 0°C to 70°C		UNIT
			MIN	TYP	MAX	MIN	MAX	
f _{max}	LDCK, UNCK					40		MHz
t _{pd}	LDCK↑	Any Q	18	26		30		ns
	UNCK↑		18	24		27		
t _{PLH}	LDCK↑	EMPTY	12	16		18		ns
t _{PHL}	UNCK↑		12	17		20		
t _{PHL}	RST↓	EMPTY	12	17		20		ns
t _{PHL}	LDCK↑	FULL	16	21		22		ns
t _{PLH}	UNCK↑	FULL	10	15		18		ns
	RST↓		13	19		23		
t _{PLH}	LDCK↑	AF/AE	22	27		30		ns
t _{PHL}			19	25		28		
t _{PLH}	UNCK↑	AF/AE	22	27		30		ns
t _{PHL}			17	23		26		
t _{PLH}	RST↓	AF/AE	12	16		18		ns
t _{PLH}	LDCK↑	HF	22	27		30		ns
t _{PHL}	RST↓		28	32		35		
t _{PHL}	UNCK↑	HF	16	22		25		ns
t _{en}	OE↑	Q	11	15		17		ns
t _{dis}	OE↓	Q	11	17		19		ns

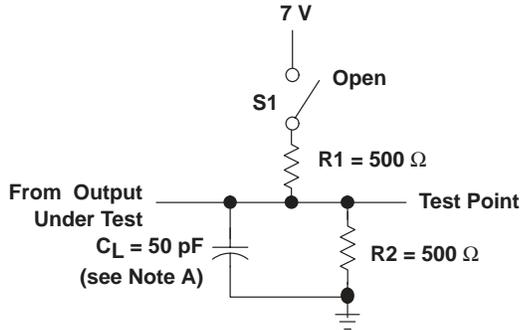


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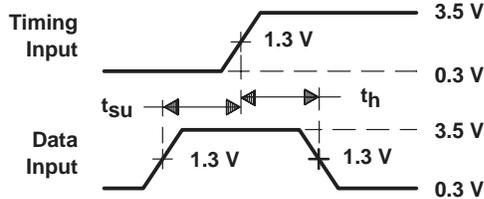
PARAMETER MEASUREMENT INFORMATION



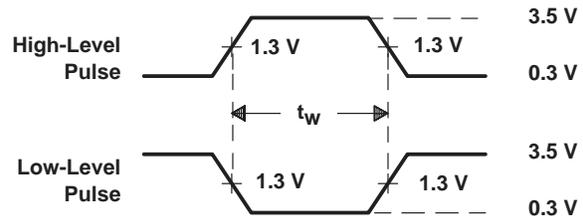
LOAD CIRCUIT FOR 3-STATE OUTPUTS

SWITCH POSITION TABLE

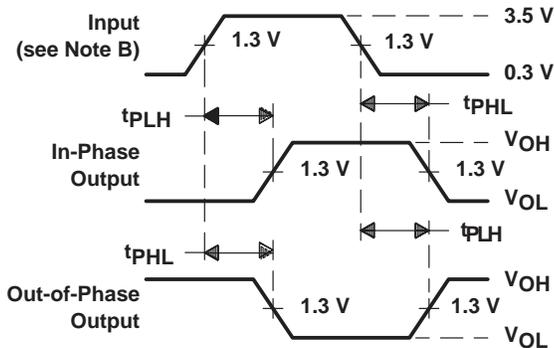
TEST	S1
t _{PLH}	Open
t _{PHL}	Open
t _{PZH}	Open
t _{PZL}	Closed
t _{PHZ}	Open
t _{PLZ}	Closed



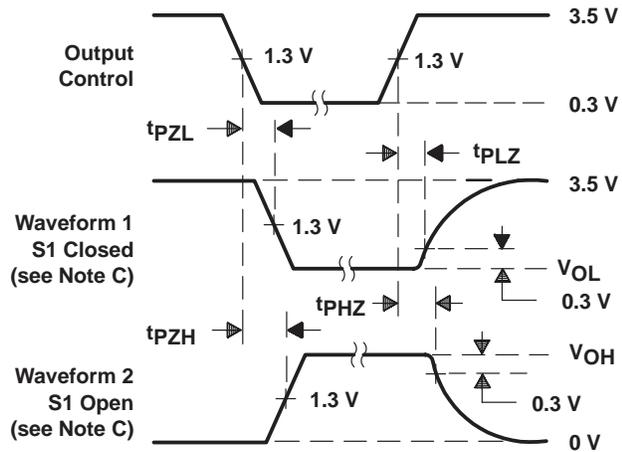
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

- NOTES: A. C_L includes probe and jig capacitance.
 B. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1$ MHz, $Z_0 = 50 \Omega$, $t_r \leq 2$ ns, $t_f \leq 2$ ns.
 C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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